





Absolute Maximum Ratings at Ta=25°C

Parameter	MAX.	Unit
Power Dissipation	150	mW
Continuous Forward Current	100	mA
Peak Forward Current ^{*1}	1.0	A
Reverse Voltage	5	V
Operating Temperature	-40°C to + 85°C	
Storage Temperature	-45°C to + 105°C	
Lead Soldering Temperature [2mm From Body]	260°C for 3 Seconds	
Lead Soldering Temperature [5mm From Body]	260°C for 5 Seconds	

1. Storage:

The storage ambient for the LEDs should not exceed 30 °C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

2. Precautions in handling:

- When soldering, leave 2mm of minimum clearance from the resin to the soldering point.
- Dipping the resin to solder must be avoided.
- Correcting the soldered position after soldering must be avoided.
- In soldering, do not apply any stress to the lead frame particularly when heated.
- When forming a lead, make sure not to apply any stress inside the resin.
- Lead forming must be done before soldering.
- It is necessary to cut the lead frame at normal temperature.

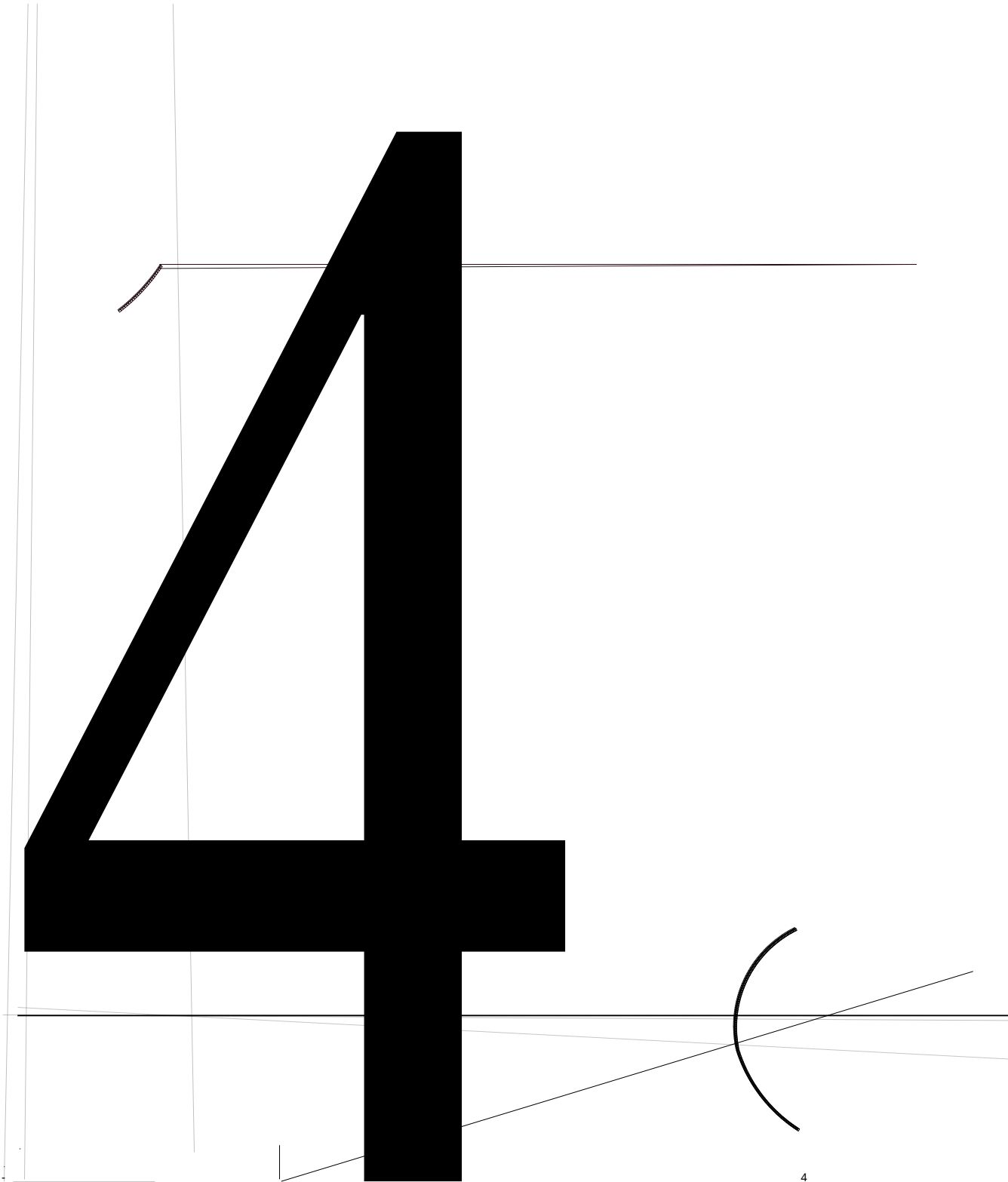
3. Peak Forward Current:

Condition for is I_{FP} pulse of 1/10 duty and 0.1 msec width.

Electrical Optical Characteristics at Ta=25°C

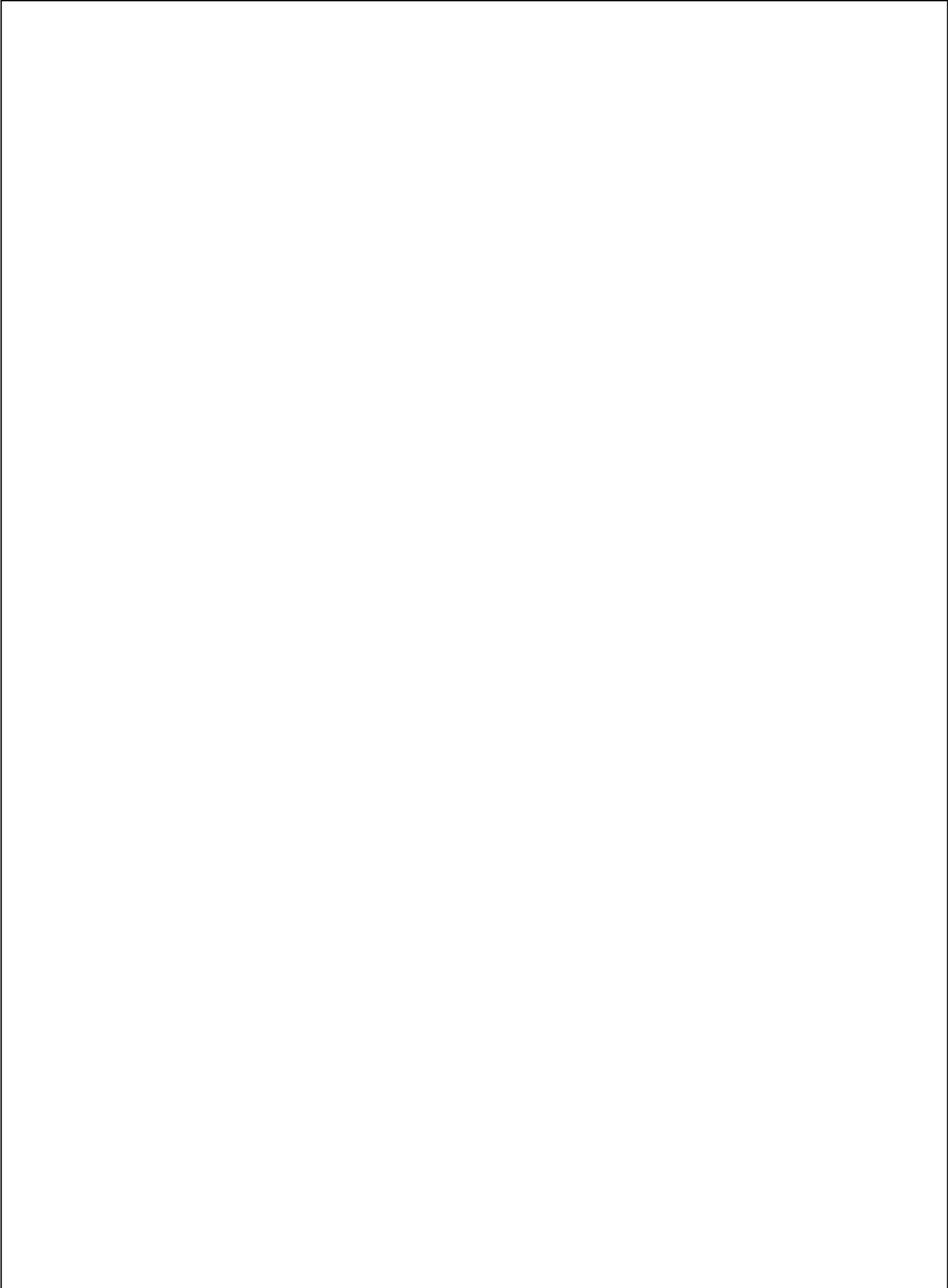
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Radiant Intensity	I _e	---	3.1	---	mW/sr	I _F =20mA (Note 1,3)
Viewing Angle	- 1/2	---	85	---	deg	(Note 2)

Typical Electrical / Optical Characteristics Curves
(25°C Ambient Temperature Unless Otherwise Noted)

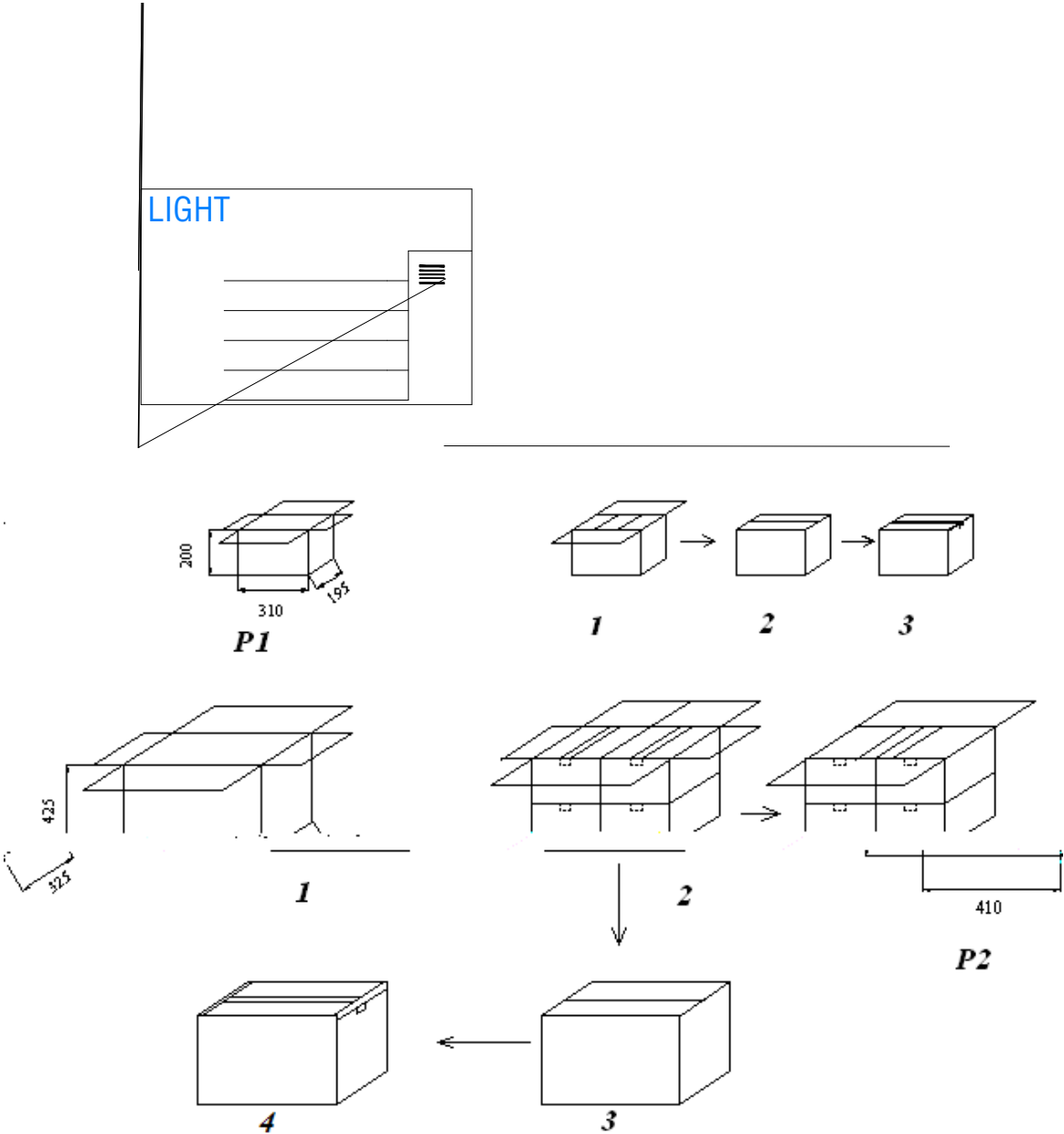


4

L



PACKAGE



Bag minimum volume (pcs / Bag)	Bag volume (pcs / Bag)	Inner box volume (Bag / box)	Outer carton volume (Box / Carton)
250	1000	10	4